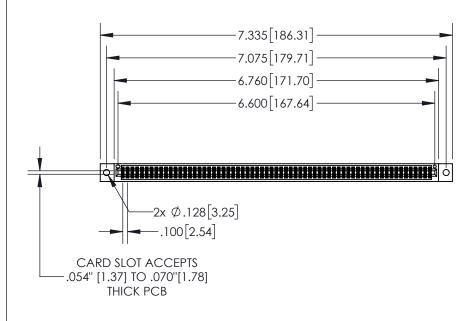
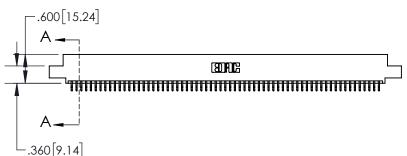
Contact Dimensions:

556-Extender Board Bend (Code 520 Contacts)
See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

1







.330[8.38] **CARD SLOT** .370[9.40] **SECTION A-A** .160 4.06 POINT OF CONTACT -.200 [5.08]

- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895	SERIES HIGH TEMP	P CARD EDG	SE CONNECTOR
PART NU	MBFR: 845-130-55	6-502	

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER		
DRAWN: R.STA.MONICA	DATE:MAY.16/2017	
CHECKED:	DATE:	
SCALE: 1:2	SHEET 1 OF 2	
DRAWING NUMBER	ISSUE	

845-ENG-MASTER







INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST

Contact Code 558

CONTACT MATERIAL; COPPER ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

Contact Code 559

	ACAD REFERENCE NO	. 845-ENG-MASTER
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017
	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

Contact Code 560

845-ENG-MASTER